Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

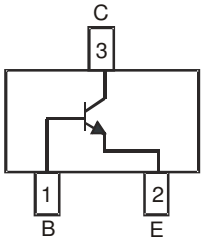
BC847BLD

SMALL SIGNAL NPN TRANSISTOR WITH CONTROLLED BASE-EMITTER VOLTAGE

Features

- Low Deviation in Base-Emitter Voltage
- Surface Mount Package
- Ideally Suited for Automated Assembly Processes
- **Lead Free by Design/RoHS Compliant (Note 1)**
- **"Green" Device (Note 2)**
- **Qualified to AEC-Q101 Standards for High Reliability**

SOT-23



Schematic & Pin Configuration

Mechanical Data

- Case: SOT-23
- Case material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: See Diagram
- Terminals: Finish - Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.008 grams (approximate)

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	50	V
Collector-Emitter Voltage	V_{CEO}	45	V
Emitter-Base Voltage	V_{EBO}	6	V
Output Current - Continuous (Note 3)	I_C	200	mA
Peak Collector Current	I_{CM}	200	mA
Peak Emitter Current	I_{EM}	200	mA
Power Dissipation (Note 3)	P_d	300	mW
Power Deration	P_{der}	2.4	mW/°C

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Ambient Air (Note 3)	$R_{\theta JA}$	417	°C/W
Operating and Storage Junction Temperature Range	T_j, T_{STG}	-55 to +150	°C

Notes:
1. No purposefully added lead.
2. Diode's Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
3. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on page 4 or on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

Electrical Characteristics: NPN Transistor @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 4)						
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	50	—	—	V	I_C = 10μA, I_E = 0
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	45	—	—	V	I_C = 1.0mA, I_B = 0
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	6	—	—	V	I_E = 10μA, I_C = 0
Collector Cutoff Current	I_{CEX}	—	—	15	nA	V_{CE} = 50V, $V_{EB(OFF)}$ = 3.0V
Base Cutoff Current (I_{BEX})	I_{BL}	—	—	15	nA	V_{CE} = 40V, $V_{EB(OFF)}$ = 3.0V
Collector-Base Cut Off Current	I_{CBO}	—	—	15	nA	V_{CB} = 40V, I_E = 0
				5	μA	V_{CB} = 30V, T_A = 150°C
Collector-Emitter Cut Off Current, $I_{O(OFF)}$	I_{CEO}	—	—	50	nA	V_{CE} = 40V, I_B = 0
Emitter-Base Cut Off Current	I_{EBO}	—	—	50	nA	V_{EB} = 5V, I_C = 0
ON CHARACTERISTICS (Note 4)						
DC Current Gain	h_{fe}	180	—	—	—	V_{CE} = 5V, I_C = 100μA
		150	—	—	—	V_{CE} = 5V, I_C = 500μA
		220	—	—	—	V_{CE} = 5V, I_C = 1mA
		220	—	—	—	V_{CE} = 5V, I_C = 2mA
		150	—	—	—	V_{CE} = 5V, I_C = 5mA
		150	—	—	—	V_{CE} = 5V, I_C = 10mA
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$	—	0.09	0.18	V	I_C = 10mA, I_B = 0.5mA
		—	0.2	0.4	V	I_C = 100mA, I_B = 5mA
Base-Emitter Turn-On Voltage	$V_{BE(ON)}$	647	657	667	mV	V_{CE} = 5V, I_C = 2mA
Base-Emitter Saturation Voltage	$V_{BE(SAT)}$	—	—	0.8	V	I_C = 10mA, I_B = 0.5mA
		—	—	0.9	V	I_C = 100mA, I_B = 5mA
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	C_{OBO}	—	3	—	pF	V_{CB} = 5.0V, f = 1.0 MHz, I_E = 0
Input Impedance	h_{ie}	—	4.5	—	KΩ	V_{CE} = 5.0V, I_C = 2mA, f = 1.0KHz
Voltage Feedback Ratio	h_{re}	—	2	—	x 10E-4	
Small Signal Current Gain	h_{fe}	—	200	—	—	
Output Admittance	h_{oe}	—	30	—	μS	
Current Gain-Bandwidth Product	f_T	100	—	—	MHz	V_{CE} = 20V, I_C = 10 mA, f = 100 MHz
Noise Figure	NF	—	—	10	dB	V_{CE} = 5V, I_C = 100μA, R_S = 1KΩ, f = 1kHz

Notes: 4. Short duration pulse test used to minimize self-heating effect.

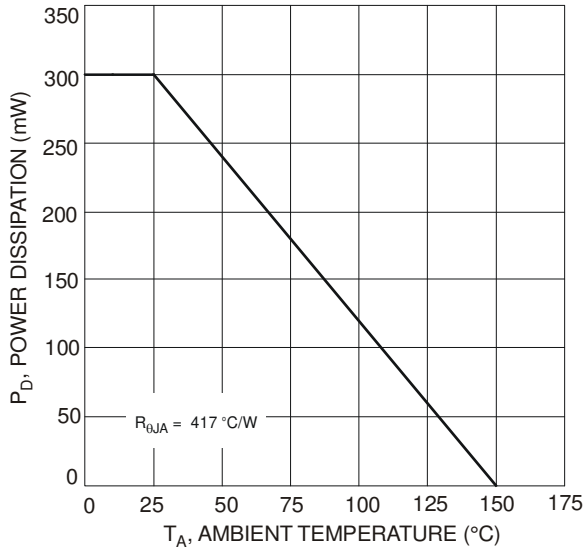


Fig. 1 Maximum Power Dissipation vs. Ambient Temperature

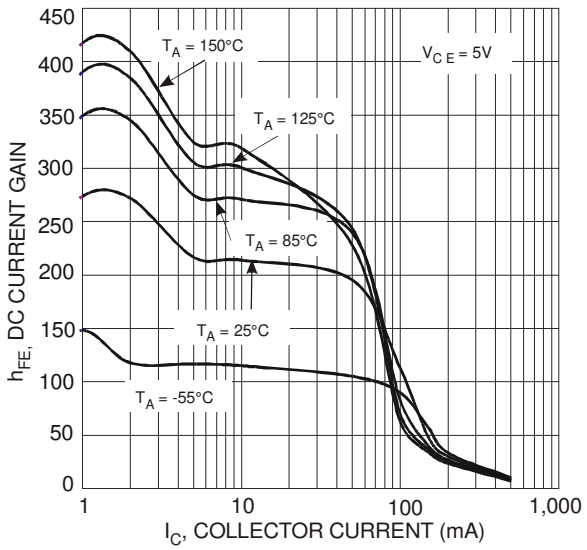


Fig. 2 Typical h_{FE} vs. I_C

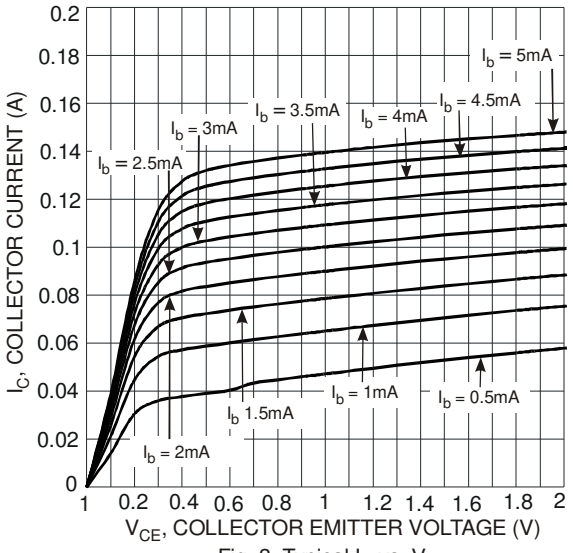


Fig. 3 Typical I_C vs. V_{CE}

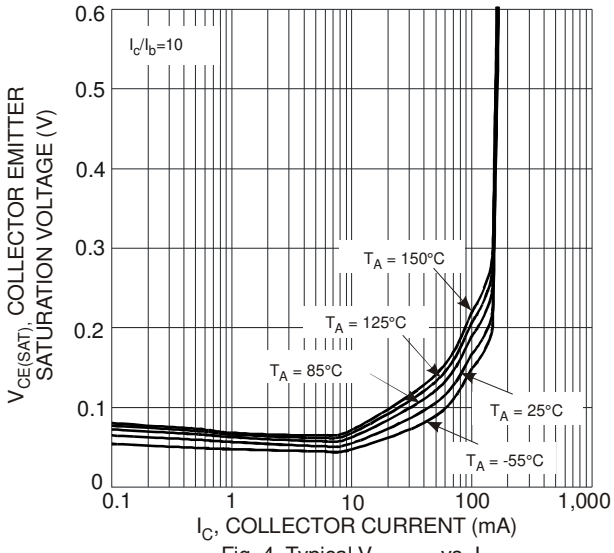


Fig. 4 Typical $V_{CE(SAT)}$ vs. I_C

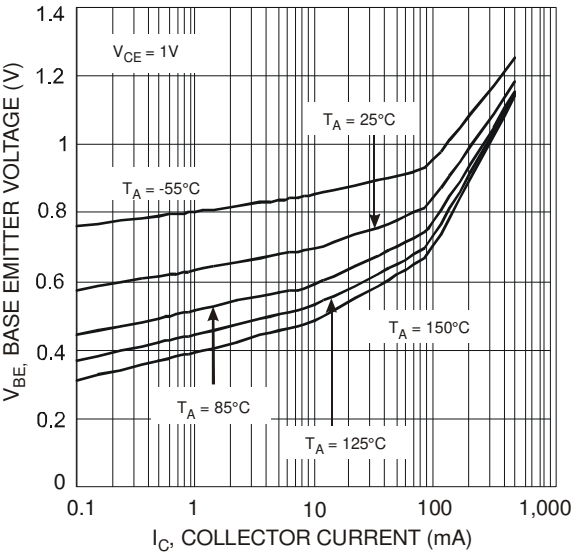


Fig. 5 Typical V_{BE} vs. I_C

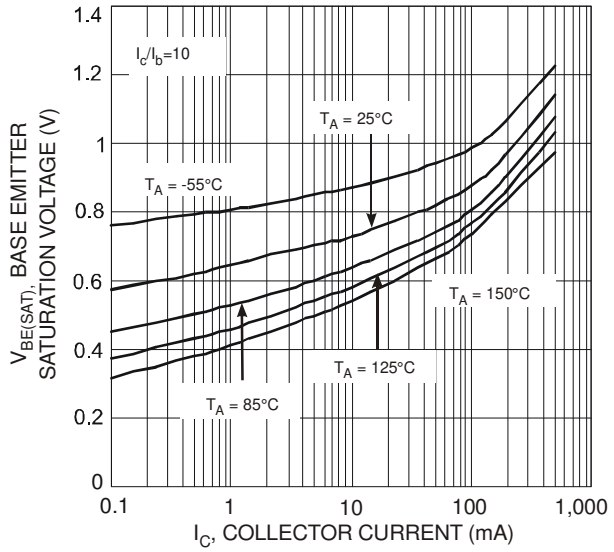


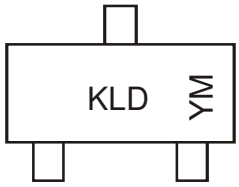
Fig. 6 Typical $V_{BE(SAT)}$ vs. I_C

Ordering Information (Note 5)

Device	Packaging	Shipping
BC847BLD-7	SOT-23	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



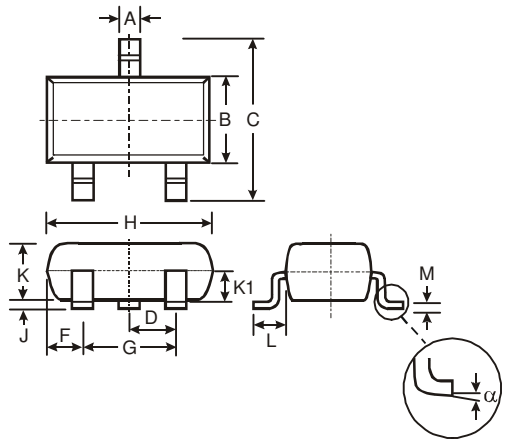
KLD = Product Type Marking Code
YM = Date Code Marking
Y = Year ex: T = 2006
M = Month ex: 9 = September

Date Code Key

Year	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
Code	T	U	V	W	X	Y	Z	A	B	C

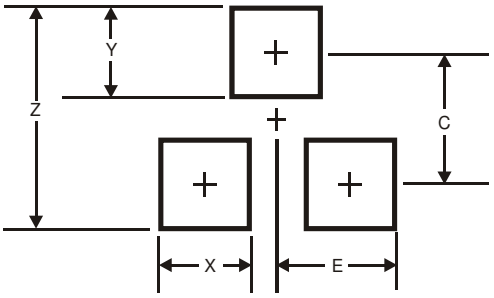
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Mechanical Details



SOT-23			
Dim	**Min**	**Max**	**Typ**
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.903	1.10	1.00
K1	-	-	0.400
L	0.45	0.61	0.55
M	0.085	0.18	0.11
α	0°	8°	-
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35